Form (Rev. 2/01)

UNITED STATES



Docket No.: 1454.1054

COMBINED DECLARATION/POWER OF ATTORNEY FARE TILITY/DESIGN PATENT APPLICATION

are listed below) of the subject matter DATA STRUCTURES AND METHOD the specification of which is attached was filed on as United States in hereby state that I have reviewed an any amendment referred to above. I acknowledge the duty to disclose in I hereby claim foreign priority benefit.	d citizenship are as stated below no not sole inventor (if only one name is r which is claimed and for which a p D FOR ADMINISTERING PATH INF hereto, unless the following box is Application Number or PCT Interna not understand the contents of the a formation which is material to patents) under 35 U.S.C. § 119(a)-(d) or § identified below any foreign applica	is listed below) or an original, first and joint inventor (if plural names patent is sought on the invention entitled: IFORMATION AND CHANGES THERETO IN AN MPLS NETWORK
Prior Foreign Application(s)		Priority NOT Claimed
00112299.3	European Patent Office	e 8 June 2000 🔲
(Number)	(Country)	Day/Month/Year Filed
	(5.5,)	
(Number)	(Country)	Day/Month/Year Filed
		International filing date of this application. (Status patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status patented, pending, abandoned)
I hereby appoint the attorneys and agents of Staas & Halsey LLP under USPTO Customer No. 21,171 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: 21171		
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Full name of sole or first inventor Mathias RAUTENBERG		
>/>	0 , 1	Date X 27.07.01
Inventor's Signature $ extstyle ex$	Kautuserg	Date
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Inventor's Signature		Date
Residence		
Mailing Address		
Additional inventors are being n	amed on separately numbered sh	sheets attached hereto.